

RF Power Field-Effect Transistor 300 W. 50 V. 175 MHz N-Channel Broadband MOSFET

M/A-COM Products

RoHS Compliant

Features

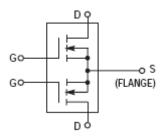
Guaranteed Performance at 175 MHz, 50 V:

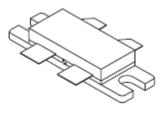
- Output Power 300 W
- Gain 14 dB (16 dB Typ)
- Efficiency 50%
- Low Thermal Resistance 0.35°C/W
- Ruggedness Tested at Rated Output Power
- · Nitride Passivated Die for Enhanced Reliability

Description and Applications

Designed for broadband commercial and military applications at frequencies to 175 MHz. The high power, high gain and broadband performance of this device makes possible solid state transmitters for FM broadcast or TV channel frequency bands.

Package Outline





CASE 375-04, STYLE 2

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|---|------------------|-------------|---------------|
| Drain-Source Voltage | V _{DSS} | 125 | Vdc |
| Drain-Gate Voltage | V_{DGO} | 125 | Vdc |
| Gate-Source Voltage | V _{GS} | ±40 | Vdc |
| Drain Current — Continuous | ID | 40 | Adc |
| Total Device Dissipation @ T _C = 25°C Derate above 25°C | PD | 500 2.85 | Watts W/°C |
| Storage Temperature Range | T _{stg} | -65 to +150 | °C |
| Operating Junction Temperature | TJ | 200 | °C |

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Max | Unit |
|--------------------------------------|------------------|------|------|
| Thermal Resistance, Junction to Case | R _{eJC} | 0.35 | °C/W |

NOTE — <u>CAUTION</u> — MOS devices are susceptible to damage from electrostatic charge. Reasonable precautions in handling and packaging MOS devices should be observed.

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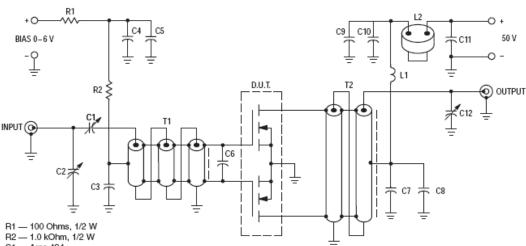


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| Characteristic | Symbol | Min | Тур | Max | Unit |
|---|----------------------|--------------------------------|-----|-----|------|
| OFF CHARACTERISTICS (Each Side) | | | | | |
| Drain-Source Breakdown Voltage (V _{GS} = 0, I _D = 100 mA) | V _{(BR)DSS} | 125 | _ | _ | Vdc |
| Zero Gate Voltage Drain Current (VDS = 50 V, VGS = 0) | I _{DSS} | _ | _ | 5.0 | mAdc |
| Gate-Body Leakage Current (V _{GS} = 20 V, V _{DS} = 0) | I _{GSS} | _ | _ | 1.0 | μAdc |
| ON CHARACTERISTICS (Each Side) | | | | | |
| Gate Threshold Voltage (V _{DS} = 10 V, I _D = 100 mA) | V _{GS(th)} | 1.0 | 3.0 | 5.0 | Vdc |
| Drain-Source On-Voltage (V _{GS} = 10 V, I _D = 10 A) | V _{DS(on)} | 1.0 | 3.0 | 5.0 | Vdc |
| Forward Transconductance (V _{DS} = 10 V, I _D = 5.0 A) | g _{fs} | 5.0 | 7.0 | _ | mhos |
| DYNAMIC CHARACTERISTICS (Each Side) | | | | | |
| Input Capacitance (V _{DS} = 50 V, V _{GS} = 0, f = 1.0 MHz) | C _{iss} | _ | 350 | l – | pF |
| Output Capacitance (V _{DS} = 50 V, V _{GS} = 0, f = 1.0 MHz) | Coss | _ | 220 | _ | pF |
| Reverse Transfer Capacitance (V _{DS} = 50 V, V _{GS} = 0, f = 1.0 MHz) | C _{rss} | _ | 15 | _ | pF |
| FUNCTIONAL TESTS | | | | | |
| Common Source Amplifier Power Gain (V _{DD} = 50 V, P _{out} = 300 W, I _{DQ} = 500 mA, f = 175 MHz) | Gps | 14 | 16 | _ | dB |
| Drain Efficiency (V _{DD} = 50 V, P _{out} = 300 W, f = 175 MHz, I _D (Max) = 11 A) | η | 50 | 55 | _ | % |
| Load Mismatch (V _{DD} = 50 V, P _{out} = 300 W, I _{DQ} = 500 mA, VSWR 5:1 at all Phase Angles) | Ψ | No Degradation in Output Power | | | |



C1 - Arco 424

C2 — Arco 404

C3, C4, C7, C8, C9 — 1000 pF Chip

C5, C10 - 0.1 µF Chip

C6 - 330 pF Chip

C11 — 0.47 µF Ceramic Chip, Kemet 1215 or Equivalent (100 V)

C12 - Arco 422

L1 - 10 Turns AWG #18 Enameled Wire,

Close Wound, 1/4" I.D.

L2 — Ferrite Beads of Suitable Material for 1.5-2.0 μH Total Inductance

Unless Otherwise Noted, All Chip Capacitors are ATC Type 100 or Equivalent.

T1 — 9:1 RF Transformer. Can be made of 15–18 Ohms Semirigid Co–Ax, 62–90 Mils O.D.

T2 — 1:4 RF Transformer. Can be made of 16–18 Ohms Semirigid Co–Ax, 70–90 Mils O.D.

Board Material — 0.062" Fiberglass (G10),

1 oz. Copper Clad, 2 Sides, $\epsilon_{\Gamma} = 5.0$

NOTE: For stability, the input transformer T1 must be loaded with ferrite toroids or beads to increase the common mode inductance. For operation below 100 MHz. The same is required for the output transformer.

See Figure 6 for construction details of T1 and T2.

Figure 1. 175 MHz Test Circuit

rigare 1. 175 mile rest circuit

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TYPICAL CHARACTERISTICS

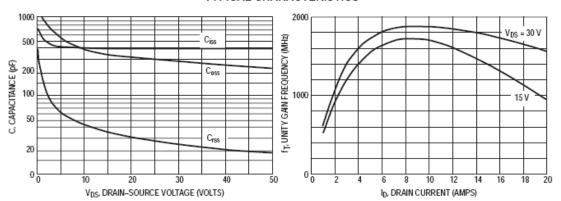


Figure 2. Capacitance versus Drain-Source Voltage*

*Data shown applies to each half of MRF151G.

Figure 3. Common Source Unity Gain Frequency versus Drain Current*

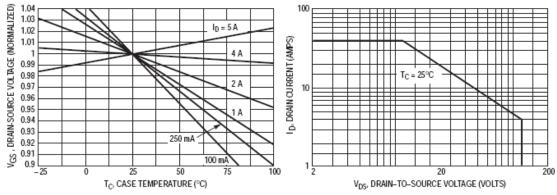


Figure 4. Gate-Source Voltage versus Case Temperature*

Figure 5. DC Safe Operating Area

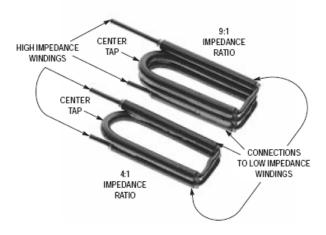


Figure 6. RF Transformer

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TYPICAL CHARACTERISTICS

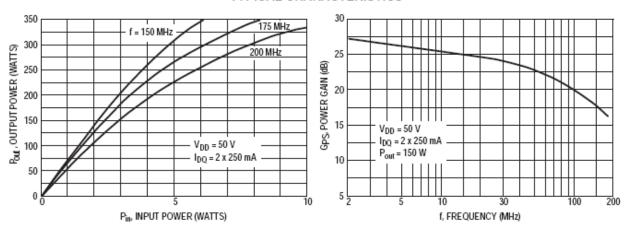


Figure 7. Output Power versus Input Power

Figure 8. Power Gain versus Frequency

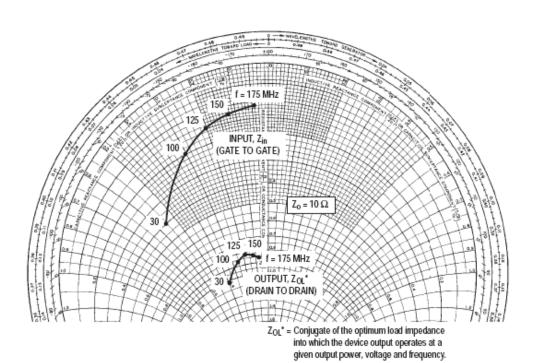


Figure 9. Input and Output Impedance

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NOTE: S-Parameter data represents measurements taken from one chip only.

Table 1. Common Source S-Parameters (VDS = 50 V, ID = 2 A)

| f | s | 11 | s | 21 | s | 12 | s | 22 |
|-----|-----------------|------|-----------------|----|-----------------|----|-----------------|------|
| MHz | S ₁₁ | ф | S ₂₁ | ф | S ₁₂ | ф | S ₂₂ | ф |
| 30 | 0.877 | -174 | 10.10 | 77 | 0.008 | 19 | 0.707 | -169 |
| 40 | 0.886 | -175 | 7.47 | 69 | 0.009 | 24 | 0.715 | -172 |
| 50 | 0.895 | -175 | 5.76 | 63 | 0.008 | 33 | 0.756 | -171 |
| 60 | 0.902 | -176 | 4.73 | 58 | 0.009 | 39 | 0.764 | -171 |
| 70 | 0.912 | -176 | 3.86 | 52 | 0.009 | 46 | 0.784 | -172 |
| 80 | 0.918 | -177 | 3.19 | 48 | 0.010 | 54 | 0.802 | -171 |
| 90 | 0.925 | -177 | 2.69 | 45 | 0.011 | 62 | 0.808 | -171 |
| 100 | 0.932 | -177 | 2.34 | 40 | 0.013 | 67 | 0.850 | -173 |
| 110 | 0.936 | -178 | 2.06 | 37 | 0.014 | 72 | 0.865 | -175 |
| 120 | 0.942 | -178 | 1.77 | 35 | 0.015 | 76 | 0.875 | -173 |
| 130 | 0.946 | -179 | 1.55 | 32 | 0.017 | 77 | 0.874 | -172 |
| 140 | 0.950 | -179 | 1.39 | 30 | 0.019 | 77 | 0.884 | -174 |
| 150 | 0.954 | -180 | 1.23 | 27 | 0.021 | 78 | 0.909 | -175 |
| 160 | 0.957 | -180 | 1.13 | 24 | 0.023 | 79 | 0.911 | -176 |
| 170 | 0.960 | 180 | 1.01 | 22 | 0.024 | 82 | 0.904 | -177 |
| 180 | 0.962 | 179 | 0.90 | 20 | 0.026 | 82 | 0.931 | -176 |
| 190 | 0.964 | 179 | 0.84 | 19 | 0.028 | 80 | 0.929 | -178 |
| 200 | 0.967 | 179 | 0.75 | 18 | 0.030 | 79 | 0.922 | -179 |
| 210 | 0.967 | 178 | 0.71 | 16 | 0.032 | 80 | 0.937 | -180 |
| 220 | 0.969 | 178 | 0.67 | 14 | 0.035 | 82 | 0.949 | 180 |
| 230 | 0.971 | 178 | 0.60 | 12 | 0.038 | 81 | 0.950 | 179 |
| 240 | 0.970 | 177 | 0.57 | 12 | 0.037 | 80 | 0.950 | 179 |
| 250 | 0.972 | 177 | 0.51 | 12 | 0.039 | 80 | 0.935 | 179 |
| 260 | 0.973 | 177 | 0.47 | 11 | 0.041 | 79 | 0.954 | 178 |
| 270 | 0.972 | 176 | 0.45 | 9 | 0.044 | 80 | 0.953 | 176 |
| 280 | 0.974 | 176 | 0.41 | 9 | 0.046 | 80 | 0.965 | 175 |
| 290 | 0.974 | 176 | 0.40 | 6 | 0.046 | 79 | 0.944 | 175 |
| 300 | 0.975 | 176 | 0.39 | 10 | 0.048 | 82 | 0.929 | 176 |
| 310 | 0.976 | 175 | 0.36 | 9 | 0.049 | 82 | 0.943 | 176 |
| 320 | 0.974 | 175 | 0.33 | 7 | 0.053 | 78 | 0.954 | 173 |
| 330 | 0.975 | 174 | 0.31 | 4 | 0.056 | 78 | 0.935 | 172 |
| 340 | 0.976 | 174 | 0.30 | 10 | 0.056 | 77 | 0.948 | 172 |
| 350 | 0.975 | 174 | 0.29 | 7 | 0.058 | 80 | 0.950 | 174 |
| 360 | 0.977 | 174 | 0.28 | 8 | 0.059 | 79 | 0.978 | 172 |
| 370 | 0.976 | 173 | 0.26 | 8 | 0.061 | 76 | 0.981 | 170 |
| 380 | 0.976 | 173 | 0.26 | 7 | 0.065 | 75 | 0.944 | 171 |
| 390 | 0.977 | 173 | 0.24 | 10 | 0.066 | 76 | 0.960 | 171 |
| 400 | 0.976 | 172 | 0.23 | 7 | 0.068 | 80 | 0.955 | 173 |
| 410 | 0.976 | 172 | 0.22 | 9 | 0.071 | 77 | 0.999 | 170 |
| 420 | 0.977 | 172 | 0.21 | 9 | 0.071 | 76 | 0.962 | 168 |

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Table 1. Common Source S-Parameters (V_{DS} = 50 V, I_D = 2 A) continued

| f | f S ₁₁ | | S ₁₁ S ₂₁ | | S ₁₂ | | S ₂₂ | |
|-----|-------------------|-----|---------------------------------|----|-----------------|----|-----------------|-----|
| MHz | S ₁₁ | ф | S ₂₁ | ф | S ₁₂ | ф | S ₂₂ | ф |
| 430 | 0.976 | 171 | 0.19 | 10 | 0.073 | 76 | 0.950 | 168 |
| 440 | 0.976 | 171 | 0.20 | 12 | 0.075 | 75 | 0.953 | 168 |
| 450 | 0.978 | 171 | 0.19 | 10 | 0.080 | 77 | 0.982 | 168 |
| 460 | 0.978 | 170 | 0.18 | 13 | 0.082 | 74 | 0.990 | 165 |
| 470 | 0.978 | 170 | 0.18 | 10 | 0.081 | 77 | 0.953 | 168 |
| 480 | 0.974 | 170 | 0.18 | 13 | 0.085 | 78 | 0.944 | 167 |
| 490 | 0.973 | 169 | 0.17 | 13 | 0.086 | 75 | 0.966 | 165 |
| 500 | 0.972 | 169 | 0.17 | 14 | 0.089 | 73 | 0.980 | 165 |

Table 2. Common Source S-Parameters (VDS = 50 V, ID = 0.38 A)

| f | s | 11 | S | 21 | s | 12 | S ₂₂ | |
|-----|-----------------|------|-----------------|----|-----------------|-----|-----------------|------|
| MHz | S ₁₁ | ф | S ₂₁ | ф | S ₁₂ | ф | S ₂₂ | ф |
| 30 | 0.834 | -168 | 9.70 | 74 | 0.014 | -10 | 0.747 | -162 |
| 40 | 0.869 | -169 | 6.47 | 62 | 0.013 | -19 | 0.731 | -159 |
| 50 | 0.883 | -170 | 5.13 | 55 | 0.012 | -24 | 0.754 | -161 |
| 60 | 0.892 | -171 | 4.03 | 51 | 0.011 | -24 | 0.823 | -164 |
| 70 | 0.901 | -172 | 3.39 | 50 | 0.010 | -20 | 0.912 | -167 |
| 80 | 0.911 | -173 | 2.80 | 47 | 0.009 | -16 | 0.996 | -168 |
| 90 | 0.924 | -173 | 2.39 | 42 | 0.008 | -14 | 1.100 | -167 |
| 100 | 0.935 | -174 | 1.99 | 35 | 0.006 | -15 | 1.100 | -167 |
| 110 | 0.945 | -174 | 1.67 | 29 | 0.005 | -17 | 1.070 | -169 |
| 120 | 0.953 | -175 | 1.36 | 25 | 0.004 | -10 | 0.988 | -167 |
| 130 | 0.958 | -175 | 1.14 | 23 | 0.004 | 4 | 0.934 | -169 |
| 140 | 0.962 | -176 | 1.01 | 23 | 0.004 | 26 | 0.935 | -170 |
| 150 | 0.964 | -177 | 0.93 | 24 | 0.004 | 45 | 0.983 | -172 |
| 160 | 0.966 | -177 | 0.85 | 24 | 0.004 | 58 | 1.080 | -173 |
| 170 | 0.969 | -178 | 0.79 | 21 | 0.005 | 61 | 1.170 | -173 |
| 180 | 0.972 | -178 | 0.74 | 17 | 0.006 | 57 | 1.250 | -173 |
| 190 | 0.975 | -178 | 0.65 | 10 | 0.007 | 56 | 1.210 | -174 |
| 200 | 0.977 | -179 | 0.56 | 8 | 0.008 | 63 | 1.110 | -174 |
| 210 | 0.979 | -179 | 0.50 | 7 | 0.008 | 72 | 1.010 | -174 |
| 220 | 0.980 | -179 | 0.44 | 9 | 0.008 | 81 | 0.958 | -172 |
| 230 | 0.980 | -180 | 0.41 | 9 | 0.009 | 79 | 1.020 | -175 |
| 240 | 0.981 | 180 | 0.38 | 12 | 0.009 | 74 | 1.020 | -178 |
| 250 | 0.982 | 180 | 0.38 | 11 | 0.011 | 74 | 1.060 | -176 |
| 260 | 0.983 | 179 | 0.34 | 8 | 0.014 | 76 | 1.180 | -179 |
| 270 | 0.984 | 179 | 0.34 | 4 | 0.014 | 80 | 1.220 | -180 |
| 280 | 0.984 | 179 | 0.30 | 3 | 0.013 | 79 | 1.180 | -179 |
| 290 | 0.984 | 178 | 0.27 | -4 | 0.012 | 73 | 1.040 | -177 |
| 300 | 0.984 | 178 | 0.25 | 0 | 0.014 | 69 | 0.996 | -178 |
| 310 | 0.984 | 178 | 0.24 | 4 | 0.017 | 74 | 0.951 | -178 |
| 320 | 0.985 | 177 | 0.23 | 7 | 0.019 | 83 | 0.964 | 179 |
| 330 | 0.985 | 177 | 0.20 | 3 | 0.019 | 90 | 1.060 | 180 |

Commitment to produce in volume is not guaranteed.

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Table 2. Common Source S-Parameters (V_{DS} = 50 V, I_{D} = 0.38 A) continued

| f | S ₁₁ | | S | 21 | s | 12 | s | 22 |
|-----|-----------------|-----|-----------------|-----------|-----------------|----|-----------------|------|
| MHz | S ₁₁ | ф | S ₂₁ | ф | S ₁₂ | ф | S ₂₂ | ф |
| 340 | 0.986 | 177 | 0.22 | 7 | 0.017 | 87 | 1.100 | 179 |
| 350 | 0.986 | 177 | 0.20 | 5 | 0.017 | 76 | 1.140 | -180 |
| 360 | 0.986 | 176 | 0.19 | -2 | 0.021 | 67 | 1.160 | 180 |
| 370 | 0.985 | 176 | 0.17 | -3 | 0.024 | 69 | 1.100 | 180 |
| 380 | 0.985 | 176 | 0.16 | -3 | 0.024 | 77 | 1.070 | -180 |
| 390 | 0.985 | 176 | 0.15 | 0 | 0.021 | 85 | 0.993 | -180 |
| 400 | 0.985 | 175 | 0.14 | 3 | 0.018 | 85 | 0.962 | -180 |
| 410 | 0.985 | 175 | 0.14 | 2 | 0.021 | 72 | 1.040 | 179 |
| 420 | 0.986 | 175 | 0.13 | 5 | 0.027 | 68 | 1.060 | 177 |
| 430 | 0.986 | 174 | 0.13 | 4 | 0.031 | 73 | 1.100 | 177 |
| 440 | 0.986 | 174 | 0.13 | 0 | 0.030 | 81 | 1.140 | 177 |
| 450 | 0.985 | 174 | 0.13 | -1 | 0.025 | 87 | 1.110 | 178 |
| 460 | 0.984 | 174 | 0.11 | -2 | 0.022 | 68 | 1.090 | 176 |
| 470 | 0.984 | 174 | 0.10 | –1 | 0.025 | 59 | 1.020 | 177 |
| 480 | 0.985 | 173 | 0.10 | 3 | 0.034 | 66 | 0.993 | 179 |
| 490 | 0.986 | 173 | 0.10 | 1 | 0.038 | 79 | 1.020 | 178 |
| 500 | 0.986 | 173 | 0.10 | 6 | 0.035 | 93 | 1.010 | 177 |

PRELIMINARY: Data Sheets contain information regarding a product M/A-COM Technology Solutions has under development. Performance is based on engineering tests. Specifications are typical. Mechanical outline has been fixed. Engineering samples and/or test data may be available. Commitment to produce in volume is not guaranteed.

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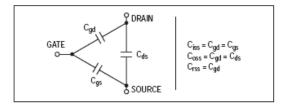
RF POWER MOSFET CONSIDERATIONS

MOSFET CAPACITANCES

The physical structure of a MOSFET results in capacitors between the terminals. The metal anode gate structure determines the capacitors from gate–to–drain ($C_{\rm gd}$), and gate–to–source ($C_{\rm gs}$). The PN junction formed during the fabrication of the RF MOSFET results in a junction capacitance from drain–to–source ($C_{\rm cls}$).

These capacitances are characterized as input (C_{iss}), output (C_{oss}) and reverse transfer (C_{rss}) capacitances on data sheets. The relationships between the inter–terminal capacitances and those given on data sheets are shown below. The C_{iss} can be specified in two ways:

- 1. Drain shorted to source and positive voltage at the gate.
- Positive voltage of the drain in respect to source and zero volts at the gate. In the latter case the numbers are lower. However, neither method represents the actual operating conditions in RF applications.



LINEARITY AND GAIN CHARACTERISTICS

In addition to the typical IMD and power gain data presented, Figure 3 may give the designer additional information on the capabilities of this device. The graph represents the small signal unity current gain frequency at a given drain current level. This is equivalent to $f_{\rm T}$ for bipolar transistors. Since this test is performed at a fast sweep speed, heating of the device does not occur. Thus, in normal use, the higher temperatures may degrade these characteristics to some extent.

DRAIN CHARACTERISTICS

One figure of merit for a FET is its static resistance in the full—on condition. This on—resistance, $V_{DS(on)}$, occurs in the linear region of the output characteristic and is specified under specific test conditions for gate—source voltage and drain current. For MOSFETs, $V_{DS(on)}$ has a positive temperature coefficient and constitutes an important design consideration at high temperatures, because it contributes to the power dissipation within the device.

GATE CHARACTERISTICS

The gate of the MOSFET is a polysilicon material, and is electrically isolated from the source by a layer of oxide. The input resistance is very high — on the order of 10° ohms — resulting in a leakage current of a few nanoamperes.

Gate control is achieved by applying a positive voltage slightly in excess of the gate-to-source threshold voltage, $V_{GS(th)}$.

Gate Voltage Rating — Never exceed the gate voltage rating. Exceeding the rated V_{GS} can result in permanent damage to the oxide layer in the gate region.

Gate Termination — The gates of these devices are essentially capacitors. Circuits that leave the gate open-circuited or floating should be avoided. These conditions can result in turn-on of the devices due to voltage build-up on the input capacitor due to leakage currents or pickup.

Gate Protection — These devices do not have an internal monolithic zener diode from gate—to—source. If gate protection is required, an external zener diode is recommended.

Using a resistor to keep the gate—to—source impedance low also helps damp transients and serves another important function. Voltage transients on the drain can be coupled to the gate through the parasitic gate—drain capacitance. If the gate—to—source impedance and the rate of voltage change on the drain are both high, then the signal coupled to the gate may be large enough to exceed the gate—threshold voltage and turn the device on.

HANDLING CONSIDERATIONS

When shipping, the devices should be transported only in antistatic bags or conductive foam. Upon removal from the packaging, careful handling procedures should be adhered to. Those handling the devices should wear grounding straps and devices not in the antistatic packaging should be kept in metal tote bins. MOSFETs should be handled by the case and not by the leads, and when testing the device, all leads should make good electrical contact before voltage is applied. As a final note, when placing the FET into the system it is designed for, soldering should be done with a grounded iron.

DESIGN CONSIDERATIONS

The MRF151G is an RF Power, MOS, N-channel enhancement mode field-effect transistor (FET) designed for HF and VHF power amplifier applications.

M/A-COM Application Note AN211A, FETs in Theory and Practice, is suggested reading for those not familiar with the construction and characteristics of FETs.

The major advantages of RF power MOSFETs include high gain, low noise, simple bias systems, relative immunity from thermal runaway, and the ability to withstand severely mismatched loads without suffering damage. Power output can be varied over a wide range with a low power dc control signal.

DC BIAS

The MRF151G is an enhancement mode FET and, therefore, does not conduct when drain voltage is applied. Drain current flows when a positive voltage is applied to the gate. RF power FETs require forward bias for optimum performance. The value of quiescent drain current (I_{DQ}) is not critical for many applications. The MRF151G was characterized at $I_{DQ} = 250$ mA, each side, which is the suggested minimum value of I_{DQ} . For special applications such as linear amplification, I_{DQ} may have to be selected to optimize the critical parameters.

The gate is a dc open circuit and draws no current. Therefore, the gate bias circuit may be just a simple resistive divider network. Some applications may require a more elaborate bias system.

GAIN CONTROL

Power output of the MRF151G may be controlled from its rated value down to zero (negative gain) by varying the dc gate voltage. This feature facilitates the design of manual gain control, AGC/ALC and modulation systems.

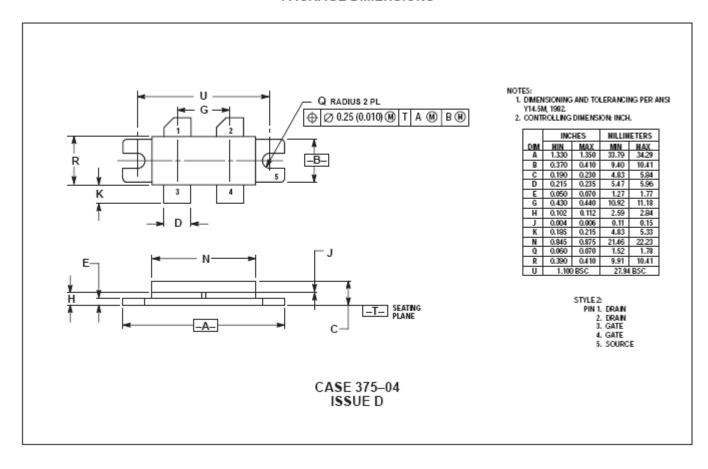
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PACKAGE DIMENSIONS



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